

TPC-DCM170S

17.0" SXGA Skylake Pcap. Panel PC

Version: 3.0



Features

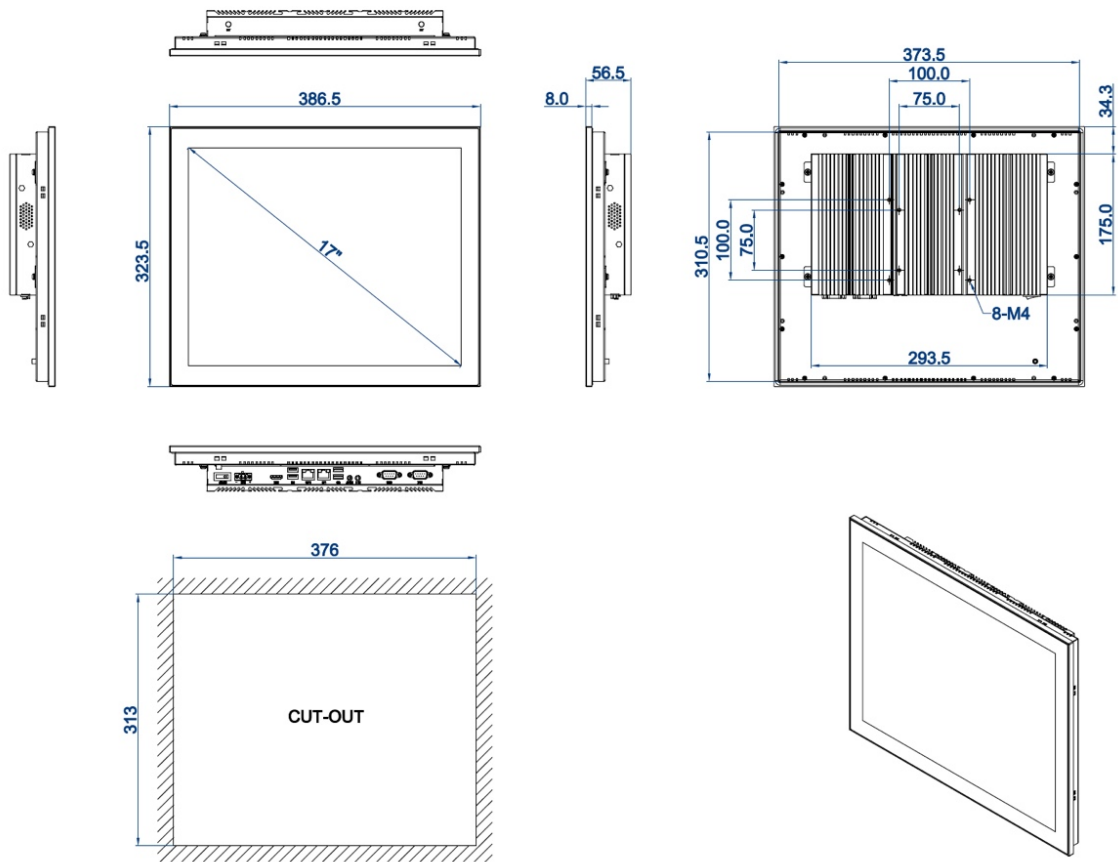
- 17.0" TFT LCD display, LED Backlit, SXGA 1280 *1024;
- Intel 6th -gen. Skylake -U Core i3/i5/i7, dual-core processor;
- Multi-points (Max. up to 10 points) Projective capacitive touch, EETI controller;
- Aluminum-magnesium alloy, anodized treatment, Modular designed;
- DC 12~24V, with over-current, over-voltage and polarity protection;
- 2*GLAN, 4*USB3.0, 2*COM, 1*HDMI, Mic-in/Line-out;
- Fan-less & Slim design, Panel mount, VESA, Front IP65 protection.

Specification

Hardware & System	BIOS	SPI AMI EEI BIOS			
	CPU	Celeron 3855U, Dual	i3-6100U, Dual core	i5-6200U, Dual-core	i7-6500U, Dual-core
		core 1.6Ghz	2.3Ghz	2.3Ghz, burst to 2.8Ghz	2.5Ghz, burst to 3.1Ghz
	Memory	SO-DIMM, DDR4, max. up to 16GB			
	Storage	1* 2.5"SATA + 1*mSATA			
	Graphic	Intel HD Graphics 520			
	Network	2* Intel I211AT (Optional 3G/4G/Wi-Fi)			
	Audio	On-board Realtek ACL 269 audio controller			
	Expansion	1* Full size Mini-PCIe slot			
	Watch dog	0~256 seconds programmable			
OS	Win7, Win8, Win embedded, Win10, Linux				
IO interface	COM	2*RS232 (Support 1x RS485)			
	Ethernet	2* RJ45, 10/100/1000 Mbps			
	Audio	Mic-in/Line-out			
	USB	4x USB3.0			
	Display	1x HDMI			
	Power	1x 2 pins, phenix terminal			
LCD Display	Size/Type	17.0" TFT LCD			
	Resolution	1280 * 1024 (SXGA)			
	Brightness	250 nits			
	Backlit & MTBF	LED backlit & 30 000hours			
	Display area	337.92 * 270.34			
	View angle	85/85/85/85			
Touchscreen	Type	Projective capacitive touchscreen			
	Touch points	Multi points touch, max. up to 10 points			
	Durability	>100 000 000 times			
	Surface hardness	Mohs 6H			
	Special treatment	Anti-fingerprint (AF)			
Structure	Structure and surface	Magnesium-Aluminum alloy, sand blasting, anodized treatment			
	Mount method	Panel mount, VESA 75/100			
	Cooling system	Large area finned heat sink			
	Overall dimension	386.5 * 323.5 * 56.5 (mm)			
	Cut-out dimension	376 * 313 (mm)			
	Net weight	4.7 KG			
	IP protection	Front Panel IP65			
Power & Environmental	Operating temp.	0 ~ +50°C			
	Storage temp.	-20 ~ +60°C			
	Relative Humidity	10 ~ 95% @ 10C (Non-condensation)			
	Vibration	50 ~ 500 Hz, 1.5G, 0.15mm peak to peak			
	Shock	10G/Peak (11 ms)			
	Power input	DC 12~24V			
	Power consumption	Around 40W			
	EMC	CE/FCC Class A			

DIMENSIONAL DRAWING:TPC-DCM170

Dimension



DIMENSIONS IN MILLIMETERS

TAICEN
DATE:2019.06.11
REV:A Unit:mm

Ordering info.

Part no.	Description
TPC-DCM170S0	17.0", 1280 * 1024, Celeron 3855U, Dual-core 1.6Ghz , Pcap. touch, 2*GLAN, 4*USB, 2*COM, 1*HDMI, Mic-in/Line-out, DC 12~24V
TPC-DCM170S1	17.0", 1280 * 1024, Core i3-6100U, Dual-core 2.3Ghz , Pcap. touch, 2*GLAN, 4*USB, 2*COM, 1*HDMI, Mic-in/Line-out, DC 12~24V
TPC-DCM170S2	17.0", 1280 * 1024, Core i5-6200U, Dual-core 2.3Ghz , Pcap. touch, 2*GLAN, 4*USB, 2*COM, 1*HDMI, Mic-in/Line-out, DC 12~24V
TPC-DCM170S3	17.0", 1280 * 1024, Core i7-6500U, Dual-core 2.5Ghz , Pcap. touch, 2*GLAN, 4*USB, 2*COM, 1*HDMI, Mic-in/Line-out, DC 12~24V
TDDR4- 4/8/16 GB1	Memory: SO-DIMM, DDR4, <u>4GB/8GB/16GB</u> Memory
TMSATA- 32/64/128/256/512 GB1	mSATA SSD: <u>32GB/64GB/128GB/256GB/512GB</u>
T25SAS- 256/512 GB1	2.5" SATA SSD: <u>256GB/512GB</u>
T25SAH- 1T/2T/4TB 1	2.5" HDD: <u>1TB/2TB/4TB</u>
TWM-WIFIA1	Wi-Fi module, with Antenna
TWM-WIFIBT1	Wi-Fi with BT integrated module, with Antenna
TWM-4GA1	All network 4G/LTE module, With Antenna
TS-2W2MS	2 * 2W Mini Speaker

Packing List

■	1x Standard Product
■	1x 60W PSU (Power Supply)
■	1x Power cable & Plug
■	8x Panel mount metal clips